

## HEAD OF DELEGATION (HoD) REPORT

U.S. Member Body of the International Organization for Standardization (ISO)



U.S. National Committee of the International Electrotechnical Commission (IEC)

Please return this report within one month of the completion of the international meeting and submit it to the appropriate ANSI Department as follows:

<u>USNC</u>

ISOT@ansi.org USNC@ansi.org

HoD reports can be used for a variety of purposes. For example:

- ❖ To report results of a TC/SC meeting to the related TAG
- **❖** To publicize the work of the TC/SC to the related US constituency via ANSI On-line, USNC News and Notes, or other media
- **❖** To suggest areas for possible development of featured articles
- **❖** To address specific challenges and concerns that the HoD may bring to the attention of related ANSI and/or USNC/IEC management

PLEASE REMEMBER: Your HoD report is NOT filed as a confidential, password protected document and, therefore, may have broad, unintended distribution. Keep this in mind when preparing the report and, if appropriate, use a more secure form of correspondence to call attention to any sensitive issues.

## Completed by:

Head of Delegation: (Please print)	Donald J. Barta	
Telephone/Telefax:	none/Telefax: (260) 421-5484	
Email:	dbarta@reawire.com	
Date:	11-11-16	

Meeting of: T	C-55	
(Designation/Title)		
Date(s) 10/7/10	6	
Location	Frankfurt, Germany	

1.	MEETING ATTENDANCE		
	Please indicate, if available, both the number of delegates and the countries represented at the Meeting:		
	In attendance: 3 officers, 13 delegates and 2 observers Countries represented: China, Germany, India, Italy, Japan, Spain, USA		
	Please comment on significant or unusual attendance issues (e.g., new member bodies, regular members not in attendance, new Chairman or Secretariat, non-accredited U.S. persons, etc.).		
	Observer: Mike Skorupa from the US (Rubadue Wire) in attendance for discussions on TIW		
	MEETING OBSERVATIONS		
2.	Overall, how well did the U.S. meet its objectives on policy or technical matters?		
	<ul> <li>Very Successful U.S. positions were accepted in whole</li> <li>Successful Compromises were reached which are acceptable to the U.S.</li> <li>Not Successful U.S. positions were not accepted</li> </ul>		
3.	Please comment on any issues of significance which might have an impact upon materially affected or interested U.S. parties.		
	Rubadue Wire is a US manufacturer of TIW, so the inclusion of this product line into TC 55 is significant. No other TC committee is interested in adopting TIW specifications into their committee.		
4.	Was there any discussion for which the United States was unprepared? (e.g., late document distribution, addition of new items, etc.)		
	No.		
5.	Did the U.S. extend an offer to assume any new TC/SC Secretariat or management positions?		
	Yes X No (If yes, please indicate which position and provide Officer contact information.)		
	Mike Leibowitz from the US already is the TC-55 Secretary.		
6.	Did the U.S. extend an offer to host any future TC/SC meetings?		
	X Yes No If yes, please identify: Fall of 2018		

7.	Were any new issues raised which require, or might involve, coordination with other U.S. bodies? (Include coordination items with other U.S. TAGs, ANSI policy-level committees (AIF, AIC, the USNC TMC and/or Council, etc.)			
	X Yes No If yes, please identify: Liaison relationship with SC 61C			
8.	Did the U.S. put forth/agree to put forth any New Work Items?			
	X Yes No If yes, please identify: Adoption of IEC 60335-2-24 Annex BB test method is continuing			
9.	Was there any evidence of irregular voting by participating countries?			
	X Yes No If yes, please identify any significant issues or concerns: Several countries are not willing to accept TIW into TC 55			
10.	Are work items in the TC or SC being affected by related work in regional standards bodies (e.g., CEN, CENELEC, ETSI, PASC, NAFTA, COPANT, etc.)?			
	Yes X No No related regional activity If yes, please explain:			
11.	Were any new issues raised which require, or might involve, coordination with emerging market countries?			
	Yes X No If yes, please explain:			
12.	Were any issues raised which relate to or impact existing U.S. regulatory matters?			
	Yes X No If yes, please explain:			
13.	Please identify any IMMEDIATE U.S. TAG actions which will be required as a result of this international meeting.			
	None			

14.	Please identify specific decisions which the U.S. delegation believes to be noteworthy for publication, publicity and/or development of a future article. If there are any, would you be willing to help develop an article for publication?		
	Yes X	No	
15.	5. What might be done to further promote the ANSI Federation's goal of "global standards that reflect U.S. interests?" (Consider such issues as how might the U.S. further promote acceptance of related American National Standards in international and, where applicable, regional fora?)		
	The US National Standards need to accepted.	use metric measurements to become more globally	
16.	Has this report been provided to yo	ur TAG Administrator for US TAG distribution?	
	Yes X	No	
17. Do you have any questions, comments, or suggestions regarding the ISO/IEC Directives, including the IEC Supplement?			
	No.		
18.	Other Comments		
	NONE		

May 2016